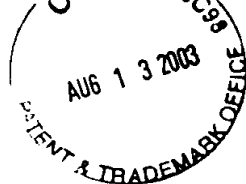




FOR: MULTILAYER COMPOSITE BASED ON POLYAMIDE/POLYOLEFIN

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(OSMMN 05/03)

[illegible]



LIST OF RELATED CASES

<u>Docket Number</u>	<u>Serial or Patent Number</u>	<u>Filing or Issue Date</u>	<u>Inventor/ Applicant</u>
0689-0692-0	6,528,137	03/04/03	FRANOSCH, et al.
0689-0693-3	6,161,879	12/19/00	RIES, et al.
0689-0754-0	6,131,618	10/17/00	BRUNDY, et al.
0689-0761-0	09/079,696	05/15/98	RIES, et al.
200723US0	09/865,687	05/29/01	SCHMITZ
201899US0	09/886,217	06/22/01	BARTZ, et al.
211217US0	10/024,386	12/21/01	SCHMITZ, et al.
213227US0	10/021,355	12/19/01	HIMMELMANN, et al.
213260US0	10/024,379	12/21/01	RIES, et al.
213811US0	10/022,878	12/20/01	SCHUELER, et al.
215747US0*	10/025,547	12/26/01	SCHMITZ, et al.
222632US0	10/269,052	10/11/02	RIES, et al.
0689-0515-0	6,386,240	05/14/02	ROEBER, et al.
0689-0567-0	5,858,492	01/12/99	ROEBER, et al.
195464US0	09/753,613	01/04/01	SCHMITZ, et al.
192058US0	6,355,358	03/12/02	BOER et al.

*Present Application; listed for information
NFO/sbr

LIST OF REFERENCES CITED BY APPLICANT

APPLICANT

Guido SCHMITZ, et al.

FILING DATE

December 26, 2001

GROUP

1714

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	6,528,137	03/04/03	FRANOSCH ET AL			
	AB	6,161,879	12/19/00	RIES ET AL			
	AC	6,131,618	10/17/00	BRUNDY ET AL			
	AD	6,386,240	05/14/02	ROEBER ET AL			
	AE	5,858,492	01/12/99	ROEBER ET AL			
	AF	6,355,358	03/12/02	BOER ET AL			
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION	
					YES	NO
	AO					
	AP					
	AQ					
	AR					
	AS					
	AT					
	AU					
	AV					

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

	AW	
	AX	
	AY	
	AZ	

☐ Additional References sheet(s) attached

Examiner

Date Considered

*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.